

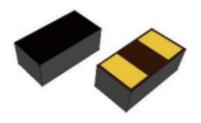
Description

The JE05B1MD10-2 help protect sensitive electronic equipment against electrostatic discharge (ESD). They supplement the on-chip protection of integrated circuitry and are best suited for low-voltage, high-speed applications where low capacitance is important. Data ports utilizing such high-speed protocols as USB 3.0, IEEE1394, HDMI and DVI can benefit from this new technology.

Circuit Diagram



Package Outline



Features

* Ultra-Low capacitance: 0.05pF (typ.)

* Low leakage: (<10nA)

* Fast response time:(<1ns)

* Low clamping voltage

* One power line protects

* Complies with following standards:

- IEC 61000-4-2 (ESD) immunity test

Air discharge: ±15kV

Contact discharge: ±8kV

* RoHS Compliant

* Package: DFN0603-2

Applications

* USB 3.0/3.1

* HDMI 1.3/1.4/2.0

* RF Antenna

External Storage

* Digital Camera

Ordering Information

Part Number	Packaging	Reel Size
JE05B1MD10-2	15000/Tape & Reel	7 inch



Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

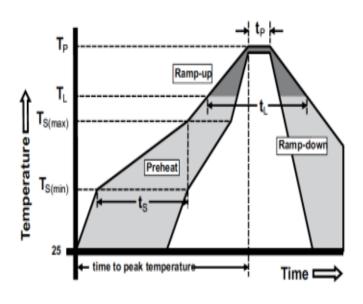
Parameter	Symbol	Value	Unit
ESD per IEC 61000-4-2 (Air)	VESD	±15	kV
ESD per IEC 61000-4-2 (Contact)	VESD	±8	K V
Operating Temperature Range	TJ	-40 to 120	°C
Storage Temperature Range	Tstg	-40 to 85	°C

Electrical Characteristics (T_A=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Continuous Operating Voltage	VDC				5	V
Trigger Voltage	VT	IEC61000-4-2 8KV Contact		450		V
Clamping Voltage	$V_{\rm C}$	IEC61000-4-2 8KV Contact		40		V
Leakage Current	IL	DC 5V shall be applied on component			10	nA
Junction Capacitance	Сл	Measured at 10MHz		0.05		pF

Soldering Parameters

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 seconds	
Average ramp up rate (Liquidus Temp (T_L) to peak		3°C/second max	
T _{S(max)} to T _t	- Ramp-up Rate	3°C/second max	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	-Temperature (t _L)	60 – 150 seconds	
PeakTemperature (T _p)		260°C	
Time within 5°C of actual peak Temperature (t _p)		10 – 30 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peakTemperature (Tp)		8 minutes max	





Typical Performance Characteristics (T_A=25°C unless otherwise Specified)

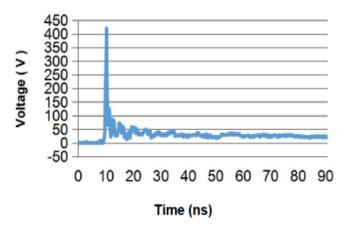


Figure 1. Typical ESD Response

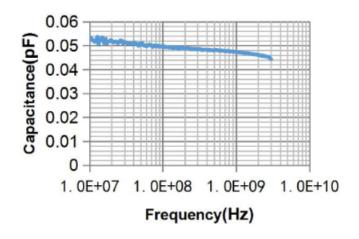


Figure 2. Typical Capacitance vs.Frequency

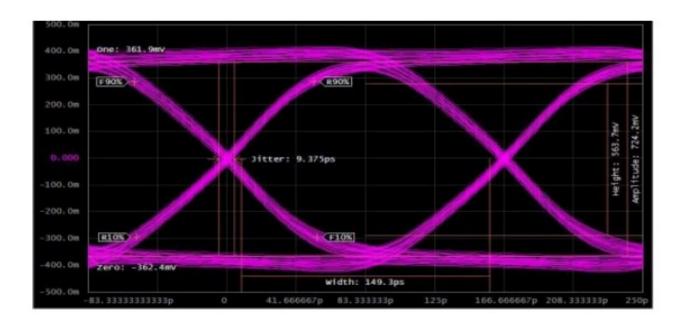
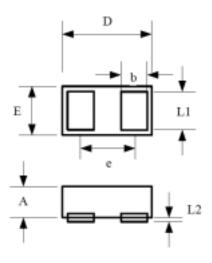


Figure 3. HDMI 2.0 Mask at 6.0 Gbps

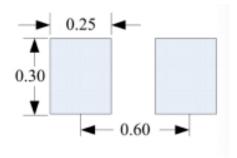


DFN0603-2 Package Outline Drawing (Dimensions in millimeters)



Dim	Millimeters		
	Min	Max	
Α	0.25	0.40	
b	0.15	0.20	
D	0.50	0.70	
E	0.25	0.35	
е	0.45 BSC		
L1	0.20	0.30	
L2	0.00	0.05	

Suggested Land Pattern



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